



# Analog Devices Welcomes Hittite Microwave Corporation

NO CONTENT ON THE ATTACHED DOCUMENT HAS CHANGED







# **HMC462LP5 / 462LP5E**



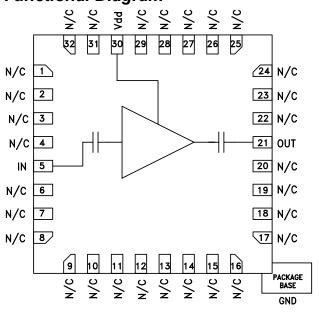
# GaAs pHEMT MMIC LOW NOISE AMPLIFIER, 2 - 20 GHz

#### **Typical Applications**

The HMC462LP5 / HMC462LP5E Wideband LNA is ideal for:

- Telecom Infrastructure
- Microwave Radio & VSAT
- Military EW, ECM & C3I
- Test Instrumentation
- Fiber Optics

#### **Functional Diagram**



#### **Features**

Noise Figure: 2.5 dB @ 10 GHz

Gain: 13 dB

P1dB Output Power: +14.5 dBm @ 10 GHz

Self-Biased: +5V @ 66mA 50 Ohm Matched Input/Output 25 mm<sup>2</sup> Leadless SMT Package

#### **General Description**

The HMC462LP5 & HMC462LP5E are GaAs MMIC pHEMT Low Noise Distributed Amplifiers in leadless 5x5 mm surface mount packages which operate between 2 and 20 GHz. The self-biased amplifier provides 13 dB of gain, 2.5 to 3.5 dB noise figure and +14.5 dBm of output power at 1 dB gain compression while requiring only 66 mA from a single +5V supply. Gain flatness is excellent from 6 - 18 GHz making the HMC462LP5 & HMC462LP5E ideal for EW, ECM RADAR and test equipment applications. The wideband amplifier I/Os are internally matched to 50 Ohms and are internally DC blocked.

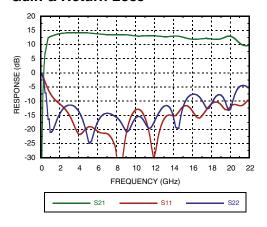
### Electrical Specifications, $T_A = +25^{\circ}$ C, Vdd=5V

Parameter	Min.	Тур.	Max.	Min.	Тур.	Max.	Min.	Тур.	Max.	Units
Frequency Range	2 - 6		6 - 14		14 - 20		GHz			
Gain	12	14		11	13		10	12		dB
Gain Flatness		±0.5			±0.5			±0.5		dB
Gain Variation Over Temperature		0.015	0.025		0.02	0.03		0.03	0.04	dB/ °C
Noise Figure		3.0	4.0		2.5	4.0		4.0	6.0	dB
Input Return Loss		15			13			11		dB
Output Return Loss		12			12			8		dB
Output Power for 1 dB Compression (P1dB)	12	15		11	14		9	12		dBm
Saturated Output Power (Psat)		17			16			15		dBm
Output Third Order Intercept (IP3)		26			25			22		dBm
Supply Current (Idd) (Vdd= 5V)	41	66	84	41	66	84	41	66	84	mA

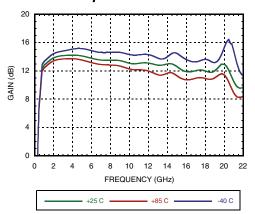




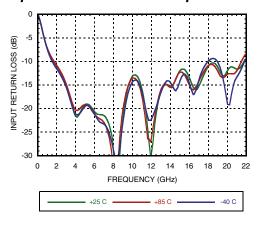
#### Gain & Return Loss



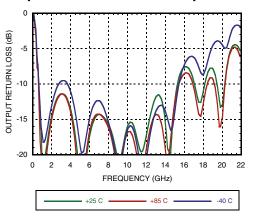
#### Gain vs. Temperature



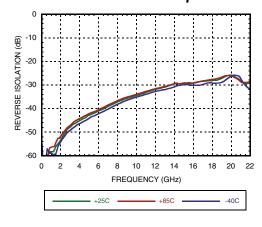
#### Input Return Loss vs. Temperature



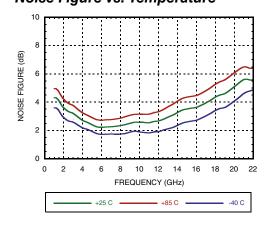
Output Return Loss vs. Temperature



#### Reverse Isolation vs. Temperature



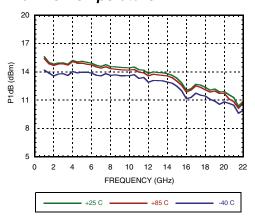
#### Noise Figure vs. Temperature



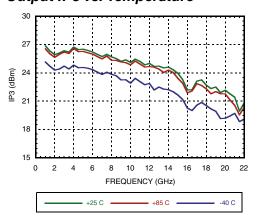




#### P1dB vs. Temperature



#### Output IP3 vs. Temperature

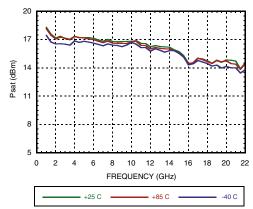


#### **Absolute Maximum Ratings**

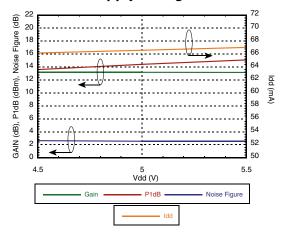
Drain Bias Voltage (Vdd)	+9 Vdc
RF Input Power (RFIN)(Vdd = +5 Vdc)	+18 dBm
Channel Temperature	150 °C
Continuous Pdiss (T = 85 °C) (derate 50 mW/°C above 85 °C)	3.25 W
Thermal Resistance (channel to ground paddle)	52 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C

# ELECTROSTATIC SENSITIVE DEVICE OBSERVE HANDLING PRECAUTIONS

#### Psat vs. Temperature



# Gain, Power, Noise Figure & Supply Current vs. Supply Voltage @ 10 GHz



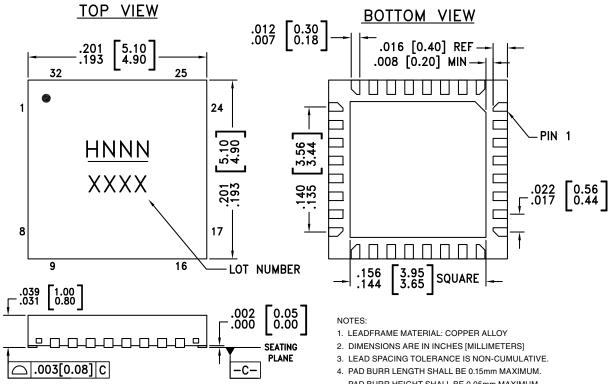
#### Typical Supply Current vs. Vdd

Vdd (V)	Idd (mA)
+4.5	66
+5.0	67
+5.5	68
+7.5	71
+8.0	72
+8.5	73





#### **Outline Drawing**



- PAD BURR HEIGHT SHALL BE 0.05mm MAXIMUM.
- 5. PACKAGE WARP SHALL NOT EXCEED 0.05mm.
- 6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.
- 7. REFER TO HITTITE APPLICATION NOTE FOR SUGGESTED

#### Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking [3]	
HMC462LP5	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL1 [1]	H462 XXXX	
HMC462LP5E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 [2]	H462 XXXX	

- [1] Max peak reflow temperature of 235 °C
- [2] Max peak reflow temperature of 260 °C
- [3] 4-Digit lot number XXXX



# HMC462LP5 / 462LP5E



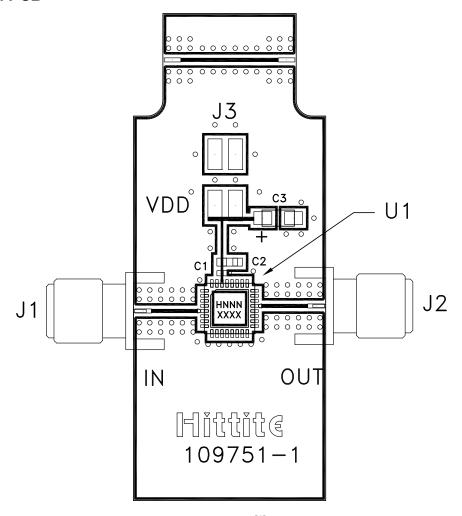
# GaAs pHEMT MMIC LOW NOISE AMPLIFIER, 2 - 20 GHz

#### **Pin Descriptions**

Pin Number	Function	Description	Interface Schematic
1 - 4, 6 - 20, 22 - 29, 31, 32	N/C	No connection. These pins may be connected to RF ground.  Performance will not be affected.	
5	RFIN	This pad is AC coupled and matched to 50 Ohms.	RFIN O——
21	RFOUT	This pad is AC coupled and matched to 50 Ohms.	—   —○ RFOUT
30	Vdd	Power supply voltage for the amplifier. External bypass capacitors are required.	Vdd
Ground Paddle	GND	Ground paddle must be connected to RF/DC ground.	○ GND =



#### **Evaluation PCB**



#### List of Materials for Evaluation PCB 108338 [1]

Item	Description	
J1 - J2	PCB Mount SMA Connector	
J3	2 mm Molex Header	
C1	100 pF Capacitor, 0402 Pkg.	
C2	1000 pF Capacitor, 0603 Pkg.	
C3	4.7 μF Capacitor, Tantalum	
U1	HMC462LP5 / HMC462LP5E	
PCB [2]	109751 Evaluation PCB	

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and package bottom should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation board should be mounted to an appropriate heat sink. The evaluation circuit board shown is available from Hittite upon request.

# **Mouser Electronics**

**Authorized Distributor** 

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Analog Devices Inc.:

HMC462LP5 HMC462LP5E HMC462LP5ETR